

ED990714  
4702-NVT390-07

# AN5539

**Panasonic**  
**MEC IC Div.**

AN5539 is a bipolar monolithic vertical deflection output IC for use in televisions, monitors and displays which are introducing bus control system as IIC. This IC amplifies sawtooth signal processed by previous stage signal processing IC and is able to drive CRT deflection yoke directly.

- < FEATURE >
- Built-in pump-up circuit
  - Built-in thermal protection circuit
  - Single-In-Line 7pin package with fin
  - Introducing dimple formed leads

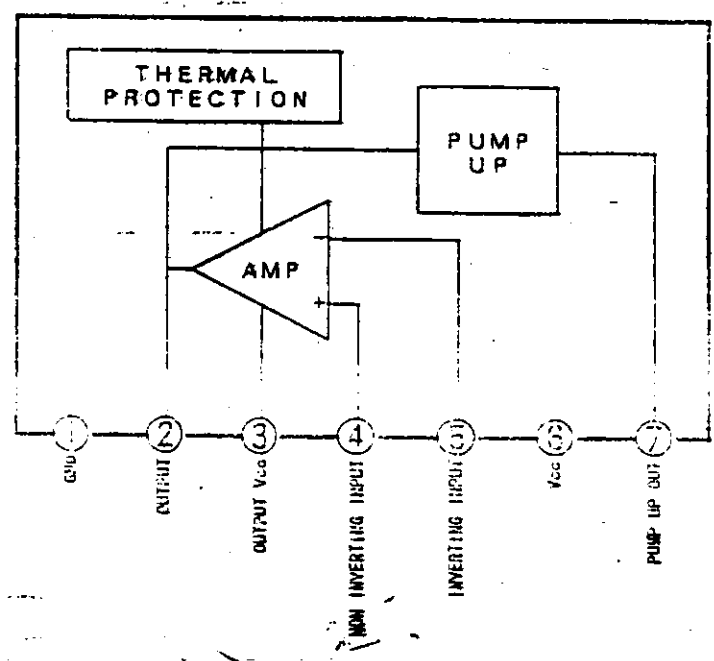
Maximum Ratings >

|                           |                |      |       |
|---------------------------|----------------|------|-------|
| supply voltage(pin6)      | Vcc6max        | 30   | V     |
| supply voltage(pin3)      | Vcc3max        | 60   | V     |
| deflection current        | I2max          | ±1.5 | A O-P |
| thermal resistance        | $\theta_{j-c}$ | 4    | °C    |
| maximum power dissipation | Pd             | 9    | W     |

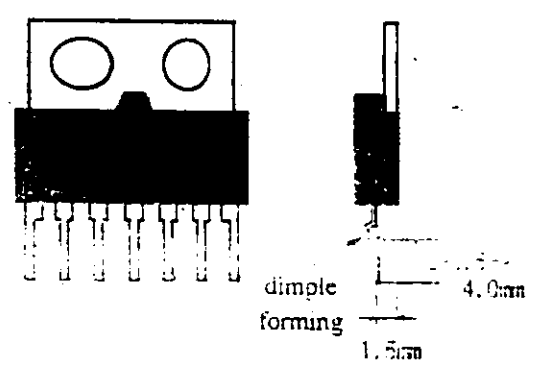
< Operating Conditions >

|                                |         |       |       |
|--------------------------------|---------|-------|-------|
| recommended supply voltage     | Vcc6    | 24    | V     |
| operating supply voltage range | Vcc6 op | 10~29 | V     |
| recommended deflection current | I2p-p   | ~2.0  | A P-P |

< Block Diagram >



< Package > FP-7S



TENTATIVE

## PRODUCT STANDARDS

AN5539

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pages

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|             |                                       |
|-------------|---------------------------------------|
| Type        | Silicon Monolithic Bipolar IC         |
| Package     | 7-Pin Plastic Package with Fin        |
| Application | TV Vertical Deflection Output Circuit |

| A Absolute Maximum Ratings |  |                |   |                         |       |  |
|----------------------------|--|----------------|---|-------------------------|-------|--|
| No.                        | Parameter                              | Symbol         | Rating  | Unit                    | Note  |  |
| 1                          | Storage temperature                    | Tstg           | -55 ~ +150  | °C                      | Note1 |  |
| 2                          | Operating ambient temperature          | Topr           | -20 ~ +70   | °C                      | Note1 |  |
| 3                          | Operating ambient atmospheric pressure | Popr           | $1.013 \times 10^5 \pm 0.61 \times 10^5$<br>(1.0 ± 0.6) | Pa<br>(atm)             |       |  |
| 4                          | Operating constant gravity             | Gopr           | 9,810<br>(1,000)  | m/S <sup>2</sup><br>(G) |       |  |
| 5                          | Operating shock                        | Sopr           | 4,900<br>(500)  | m/S <sup>2</sup><br>(G) |       |  |
| 6                          | Supply voltage                         | Vcc6           | 30  | V                       |       |  |
| 7                          | Supply current                         | Icc6           | 360   | mA                      |       |  |
| 8                          | Power dissipation                      | P <sub>D</sub> | 1.5   | W                       | Note2 |  |
| 9                          | Circuit voltage                        | V2-1           | 0   | 60                      | V     |  |
| 10                         | Circuit voltage                        | V3-1           | 0   | 60                      | V     |  |
| 11                         | Circuit voltage                        | V4-1           | 0   | V6-1                    | V     |  |
| 12                         | Circuit voltage                        | V5-1           | 0   | V6-1                    | V     |  |
| 13                         | Circuit current                        | I2             | -2.2  | 2.2                     | A0-P  |  |
| 14                         | Circuit current                        | I7             | -1.8  | 1.8                     | A0-P  |  |

|                                |      |             |
|--------------------------------|------|-------------|
| Operating supply voltage range | Vcc6 | 12 V ~ 29 V |
|--------------------------------|------|-------------|

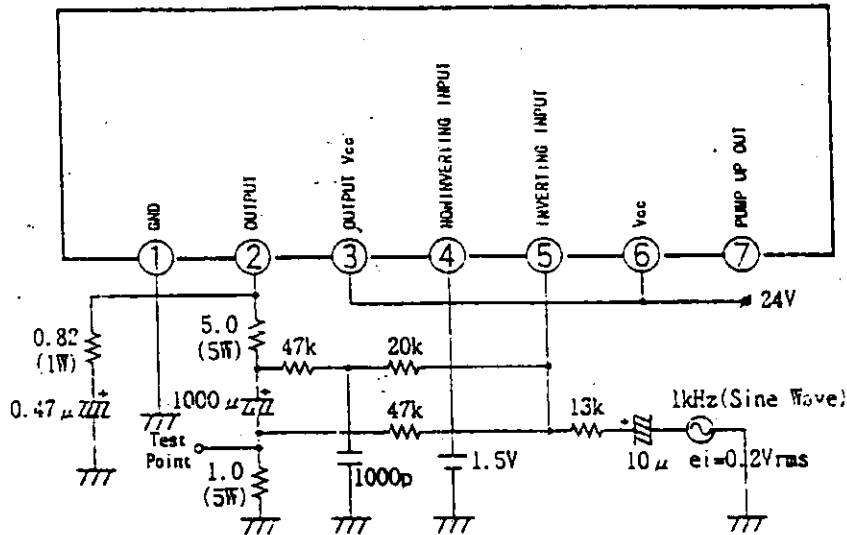
Note1 : The temperature of all parameters shall be Ta=25°C except storage temperature, operating ambient temperature and power dissipation.

Note2 : The power dissipation shall be at Ta=70°C in free air, without heat sink.  
(refer to sheet No.10)

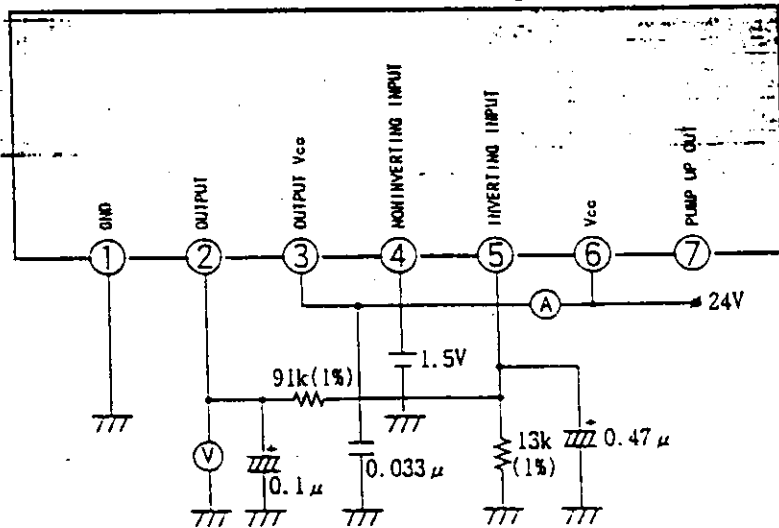
9-FEB-98



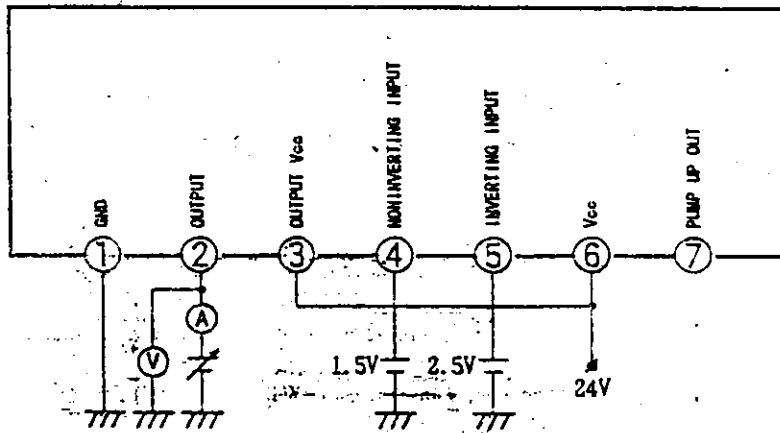
Test Circuit-1 ( Deflection current , Vertical amp. distortion )



Test Circuit-2 ( Mid-point voltage , Idling current )

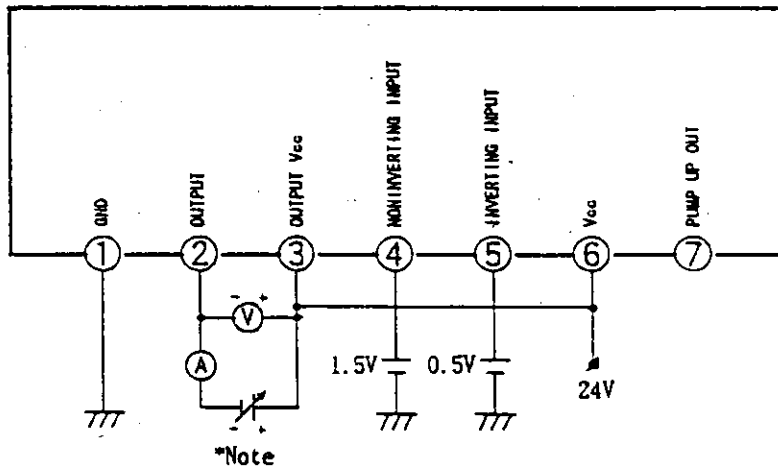


Test Circuit-3 ( Output saturation voltage (Lower) )



Monitor the voltage when the current is 0.9A.

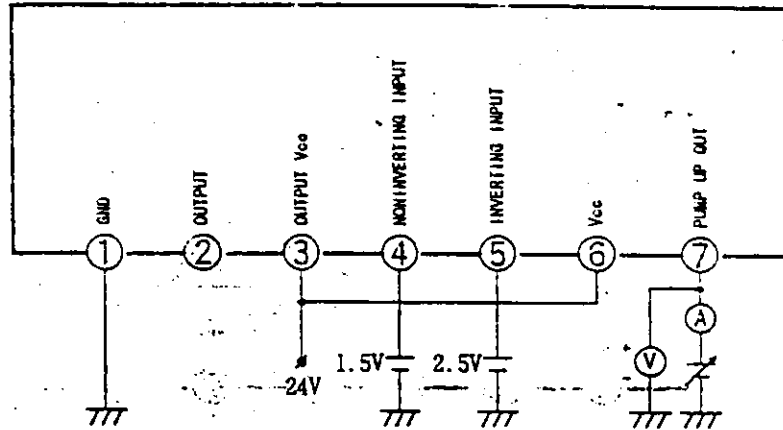
Test Circuit-4 ( Output saturation voltage (Upper) )



Monitor the voltage when the current is 0.9A.

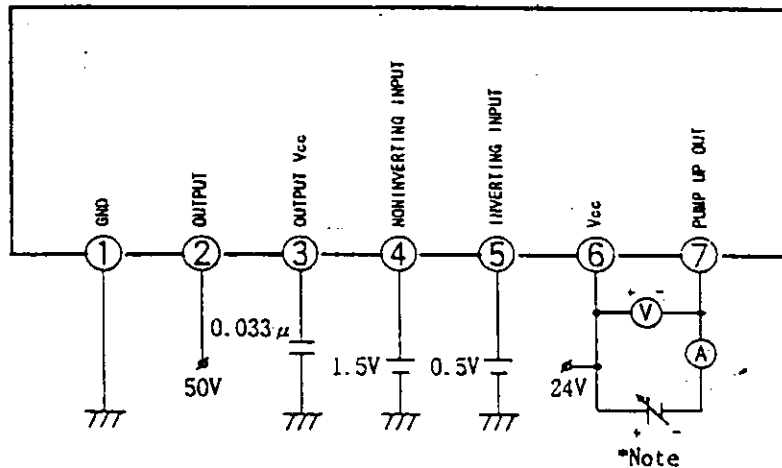
\*Note : In case an external power supply is used, set the GND terminal open(floating).

Test Circuit-5 ( Pump-up charge saturation voltage )



Monitor the voltage when the current is 20mA.

Test Circuit-6 ( Pump-up discharge saturation voltage )

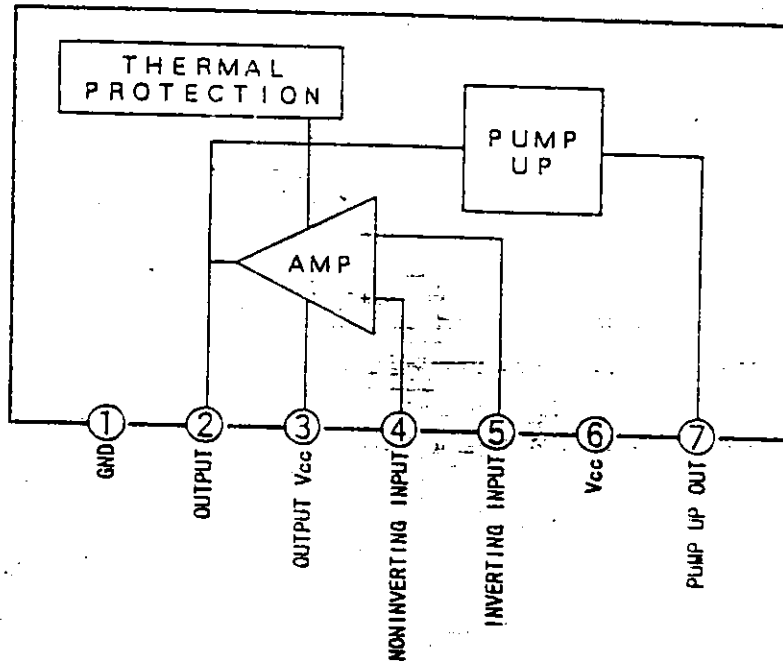


\*Note

Monitor the voltage when the current is 0.9A.

\*Note : In case an external power supply is used, set the GND terminal open(floating).

[ Block Diagram ]



[ Pin Assignment ]

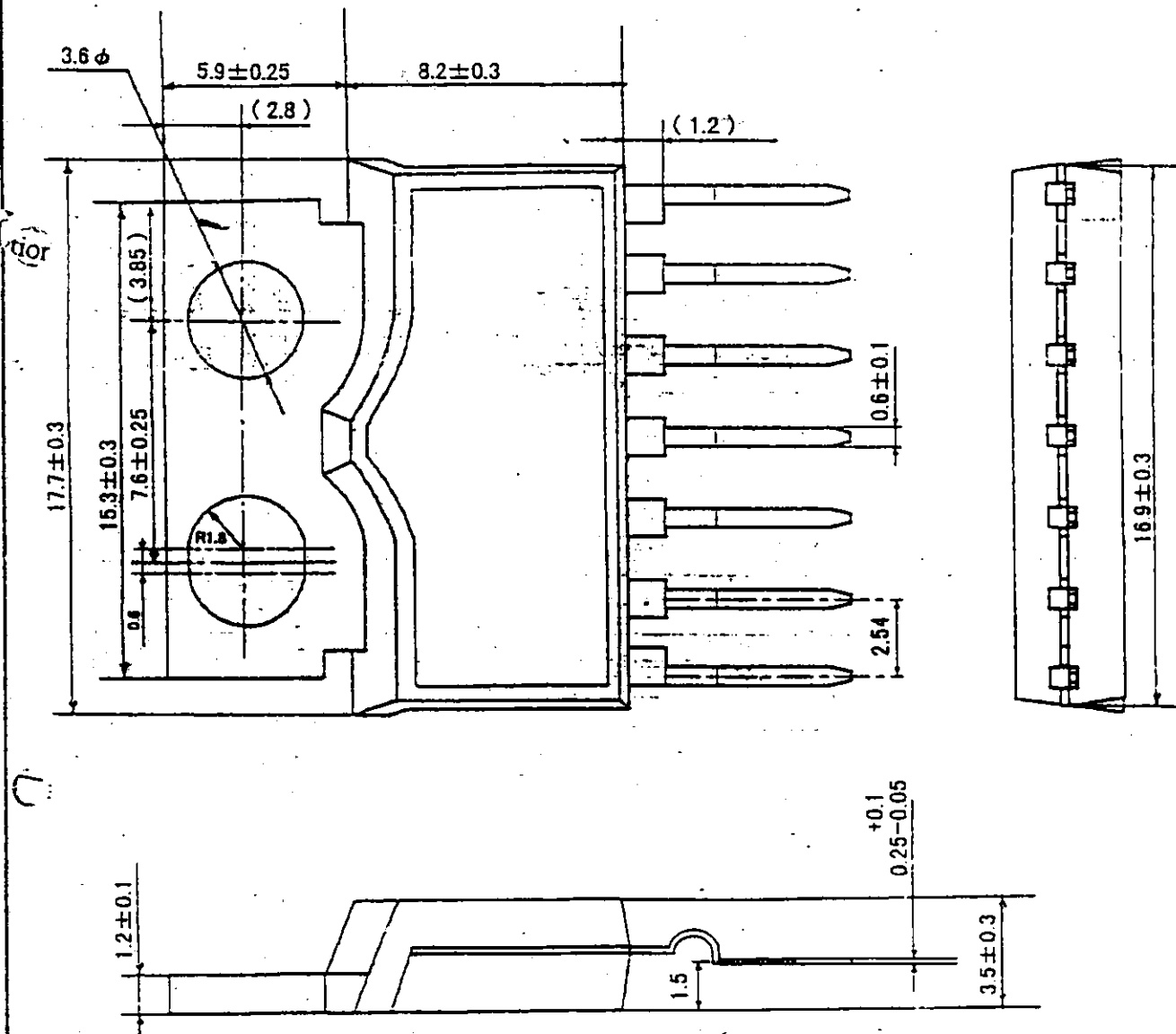
| Pin No. | Pin Description              |
|---------|------------------------------|
| 1       | GND                          |
| 2       | Vertical output              |
| 3       | Vertical output power supply |
| 4       | Noninverting input           |
| 5       | Inverting input              |
| 6       | Power supply                 |
| 7       | Pump-up output               |

Package Name

FP-7S

**Tentative**

Unit : mm



( ) : Reference data



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**Tentative**

Package Name

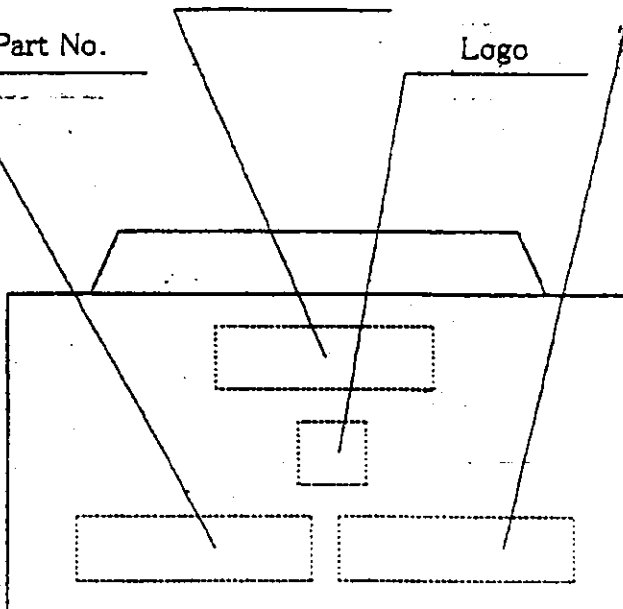
FP-7S

Country  
of origin

Date code

Part No.

Logo

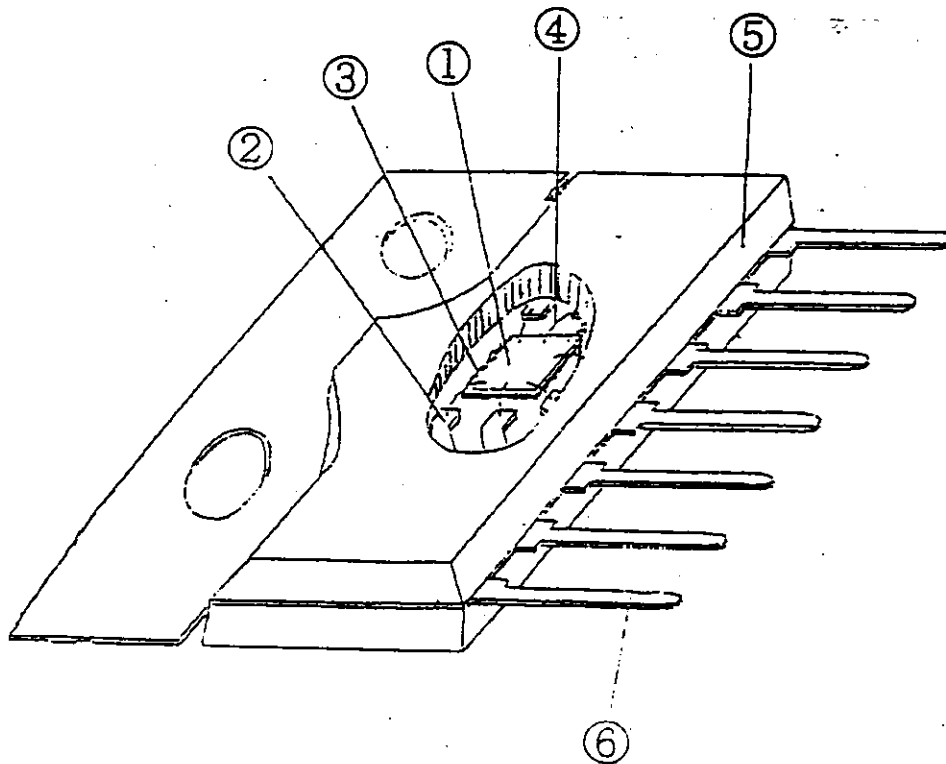


[ Structure ]

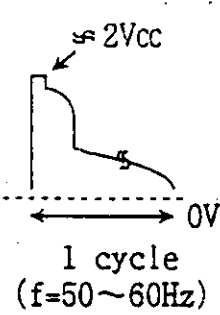
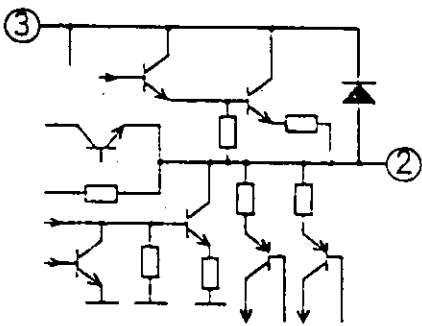
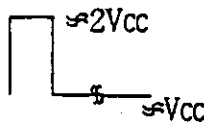
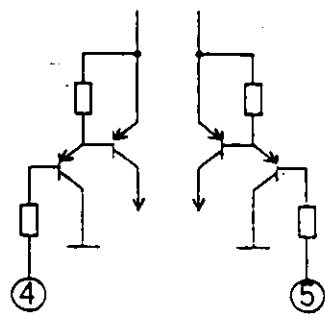
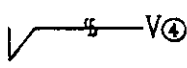
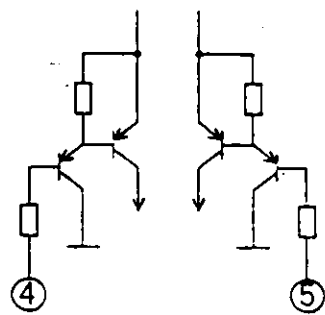
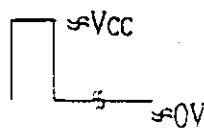
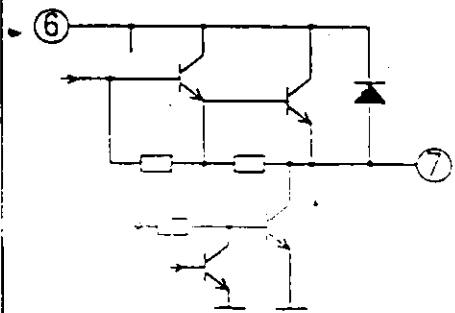
|                                 |                            |      |
|---------------------------------|----------------------------|------|
| Chip surface passivation        | PSG                        | ①    |
| Lead frame material             | Cu group                   | ②, ⑥ |
| Internal lead surface treatment | Ag plating                 | ②    |
| External lead surface treatment | Solder dip                 | ⑥    |
| Chip mounting method            | Solder                     | ③    |
| Wire bonding method             | Thermosonic bonding        | ④    |
| Wire material, diameter         | Au , Diameter : 38 $\mu$ m | ④    |
| Mold material                   | Epoxy                      | ⑤    |
| Molding method                  | Transfer mold              | ⑤    |

< Package >

FP-7S



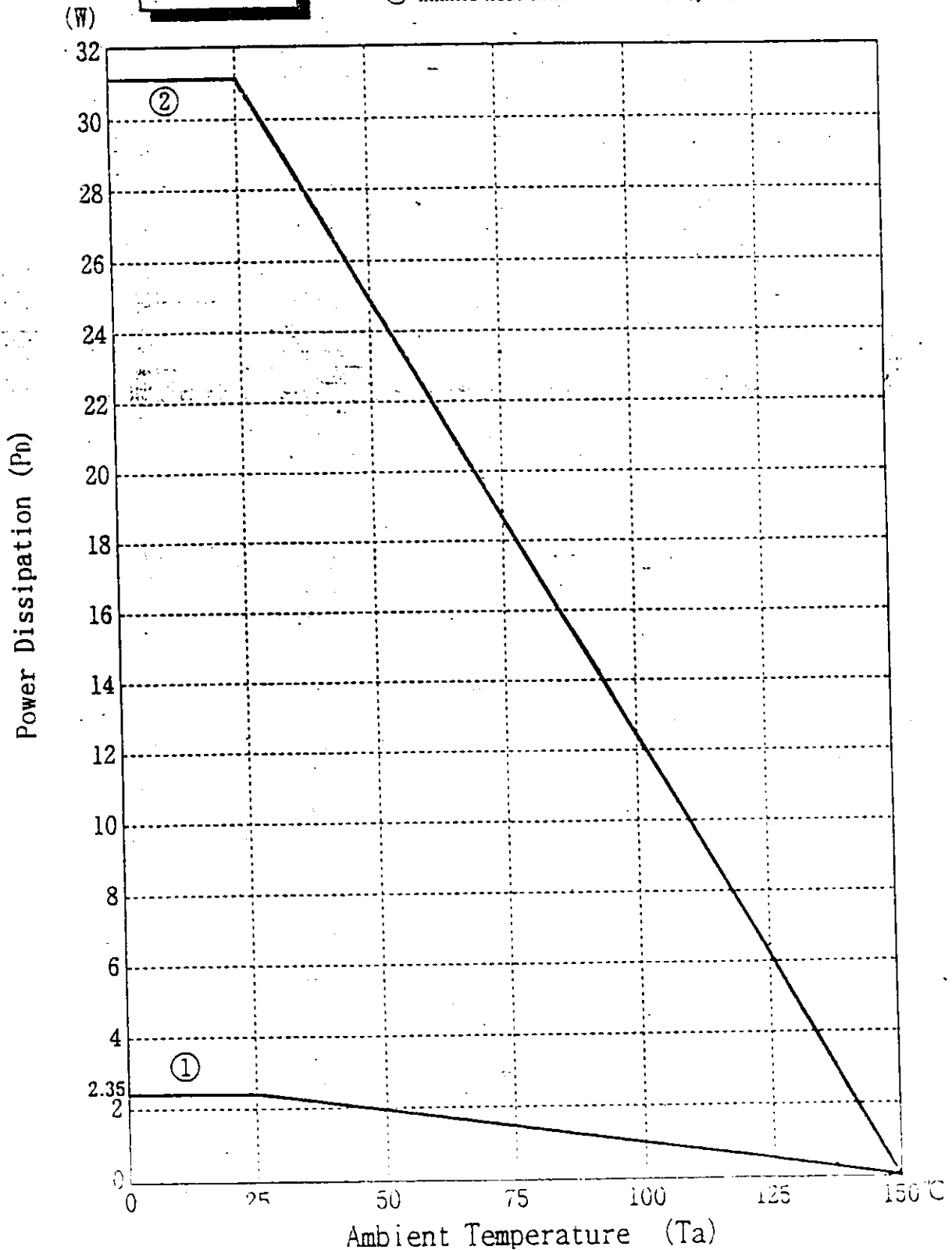
< Pin Description >

| Pin No. | Pin Name                     | Signal Wave Form  | Description   | Equivalent Circuit  |
|---------|------------------------------|---|---|---|
| ①       | GND                          | DC  | —   | —   |
| ②       | Vertical Output              |    | A vertical deflection coil is connected and 1~2A of deflection current is provided through the pin.   |    |
| ③       | Vertical Output Power Supply |   | About $V_{cc} \times 2$ for flyback period and $V_{cc} - V_D$ for the other period are supplied.  | —   |
| ④       | Noninverting Input           | DC (External Bias)  | About 2V is supplied. Very high sensitivity may cause abnormal oscillation.   |  |
| ⑤       | Inverting Input              |  | Input signal and CR network for feedback are connected. Very high sensitivity.  |  |
| ⑥       | Power supply (Vcc)           | DC  | 10~29V is supplied.   | —   |
| ⑦       | Pump-up Output               |  | A capacitor connected between this pin and pin③ is charged and discharge during flyback pulse in order to supply about $V_{cc} \times 2$ to pin③. |   |

FP-7S Ambient Temperature ( $T_a$ ) vs Power Dissipation ( $P_D$ )

**Tentative**

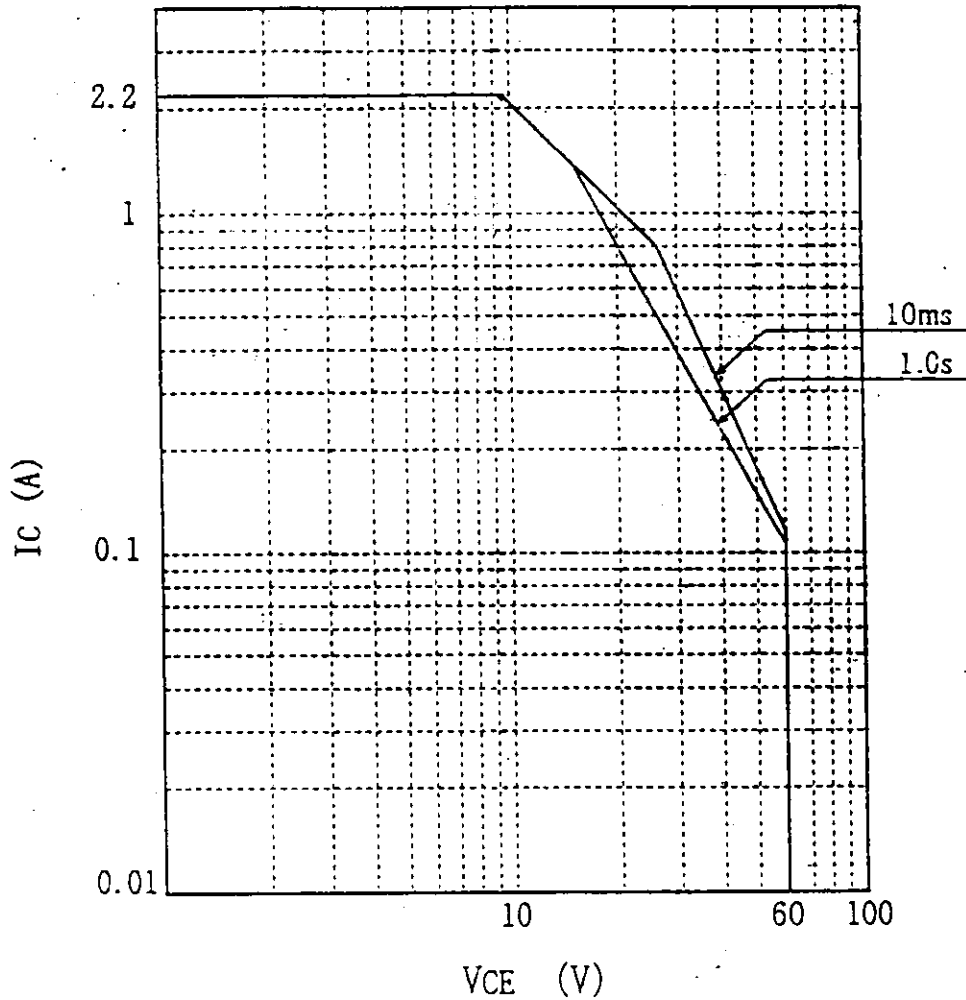
- ① Without heat sink :  $R_{th(j-a)} = 53.2^\circ\text{C/W}$
- ② Infinite heat sink :  $R_{th(j-c)} = 4^\circ\text{C/W}$



Output Transister Forward Bias ASO(Area of Safe Operation)

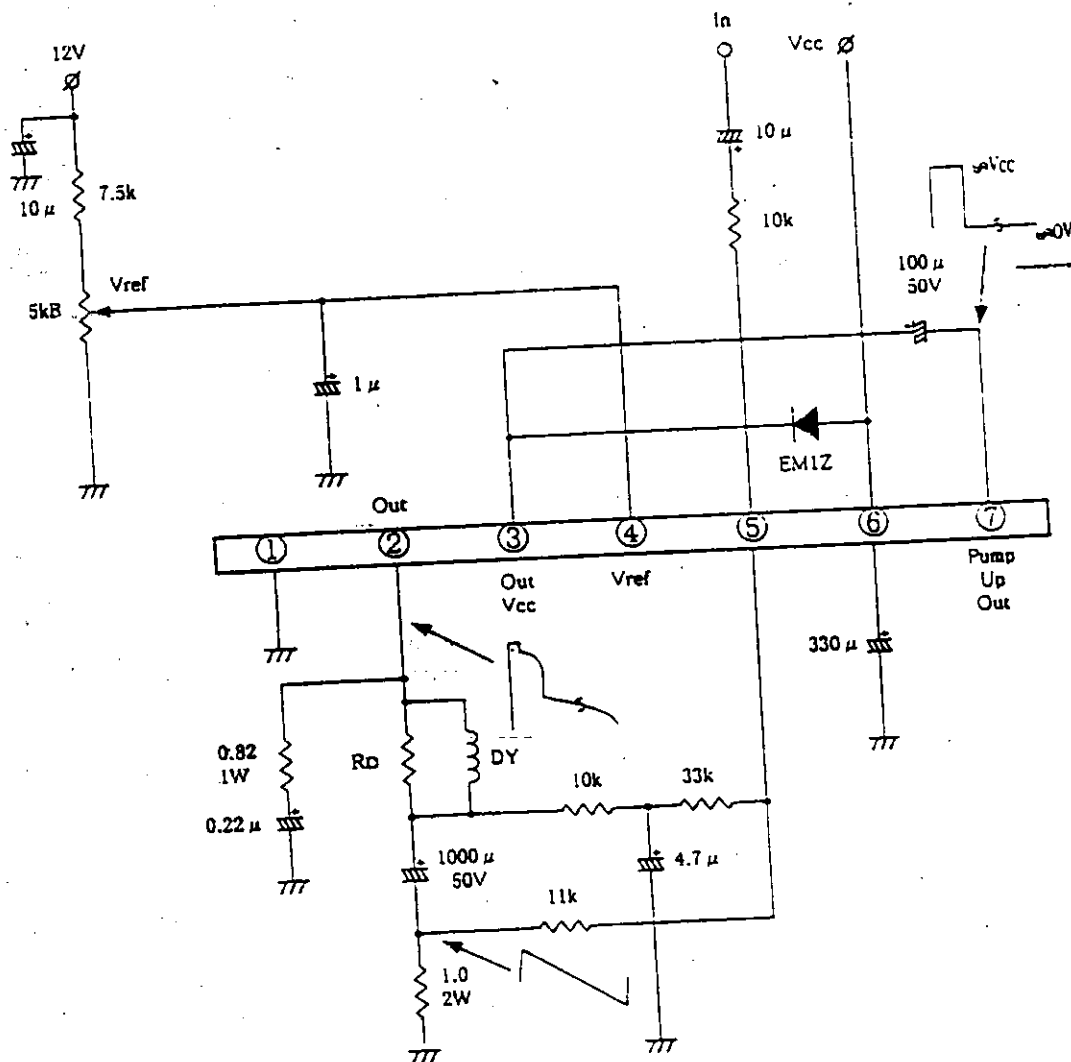
Tentative

Ta=25°C  
Single Pulse



Note : The max. deflection current value suitable for practical use is within  $\pm 1.5A_0-P(3AP-P)$

< Application Circuit >



< Precautions for application >

Test result of short between pins

Test condition : Vcc=30V  
DC Power Supply(30V, 5A)

|         |   |   |   |   |   |   |   |
|---------|---|---|---|---|---|---|---|
| 1       |   |   |   |   |   |   |   |
| 2       | × |   |   |   |   |   |   |
| 3       | ⊗ | × |   |   |   |   |   |
| 4       | ○ | ○ | ○ |   |   |   |   |
| 5       | ○ | ○ | ○ | ○ |   |   |   |
| 6       | ⊗ | ○ | ○ | ○ | ○ |   |   |
| 7       | ○ | ○ | ○ | ○ | ○ | ○ |   |
| Pin No. | 1 | 2 | 3 | 4 | 5 | 6 | 7 |

○ : No destruction of IC

× : Destruction of IC

⊗ : No destruction of IC but possible damage of external power supply

※ : A short circuit between pin2(Vertical output) and pin1(GND) or between pin2 and pin3(Vertical output power supply) may cause IC destruction. After the destruction, continuous supply of Vcc may cause smoke from the IC. Therefore full attention should be paid when this IC is used. For example, some external current limiter like a small resistor should be connected to pin6.